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LIST OF PUBLICATIONS FORS

APPLICANT'S INFORMATION

DISCLOSURE STATEMENT

Applicant(s): C.J. Miller et al.

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U.S. PATENT DOCUMENTS **EXAMINER FILING DATE** INITIAL DOCUMENT NO. DATE NAME IF APPROPRIATE FOREIGN PATENT DOCUMENTS **EXAMINER** TRANSLATION INITIAL DOCUMENT NO. DATE COUNTRY CLASS/SUBCLASS YES **OTHER DOCUMENTS EXAMINER** <u>AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.</u> INITIAL

1. V. Solberg, "Adapting Fine-Line Flex Circuits for 3D Multiple Die Packaging," Semiconductor Manufacturing, pp. 94-108, June 2003.

Examiner Date Considered

As Su Lympa Sarhar 11705

Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line

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